



Mini-Circuits

THIN FILM SURFACE MOUNT

Bandpass Filter

ABF-13G+

50Ω

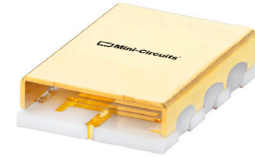
11.6 to 14.4 GHz

KEY FEATURES

- Low Passband Insertion Loss of 1.1 dB Typ.
- High Rejection of 55 dB Typ.
- Good Return Loss of 14 dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm

APPLICATIONS

- X-Band Radar
- Test and Measurements

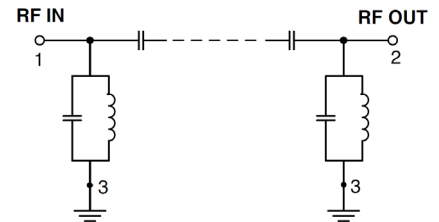


Generic photo used for illustration purposes only

PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40 GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

FUNCTIONAL DIAGRAM



ELECTRICAL SPECIFICATIONS^{1,2,3} AT +25°C

Parameter	F#	Frequency (GHz)	Min.	Typ.	Max.	Units
Pass Band	Center Frequency ⁴	—	—	13	—	GHz
	Insertion Loss	F1-F2	—	1.1	2.5	dB
	Return Loss	F1-F2	—	14	—	dB
Stopband, Lower	Rejection	DC-F3	40	55	—	dB
		F3-F4	20	40	—	dB
Stopband, Upper	Rejection	F5-F6	30	41	—	dB
		F6-F7	25	32	—	
		F7-F8	—	25	—	

1. Tested on Evaluation Board P/N TB-ABF-13G+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.

2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.

3. This component is not intended for use as a DC-blocking circuit element. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

4. Typical variation ±3%.

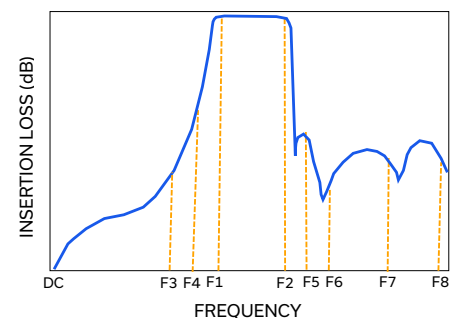
ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
Input Power ⁶	9.5 W Max. at 25°C

5. Permanent damage may occur if any of these limits are exceeded.

6. Power rating applies only to signals within the passband. Derated power at +125°C is 2.9 W

TYPICAL FREQUENCY RESPONSE AT +25°C



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REV. OR
ECO-024893
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EDU4858
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PAGE 1 OF 6



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THIN FILM SURFACE MOUNT

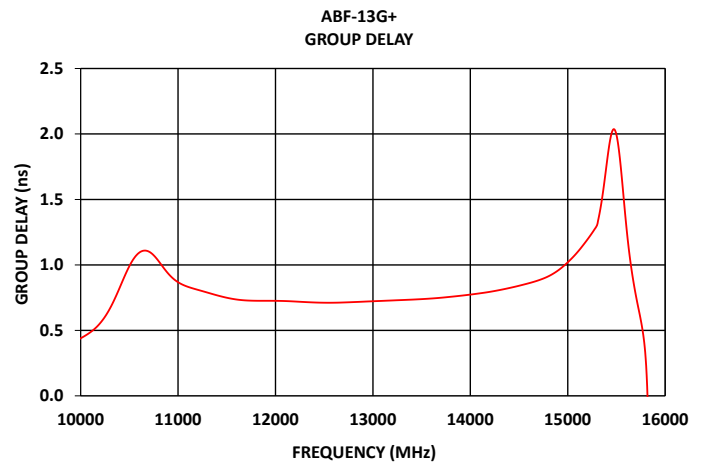
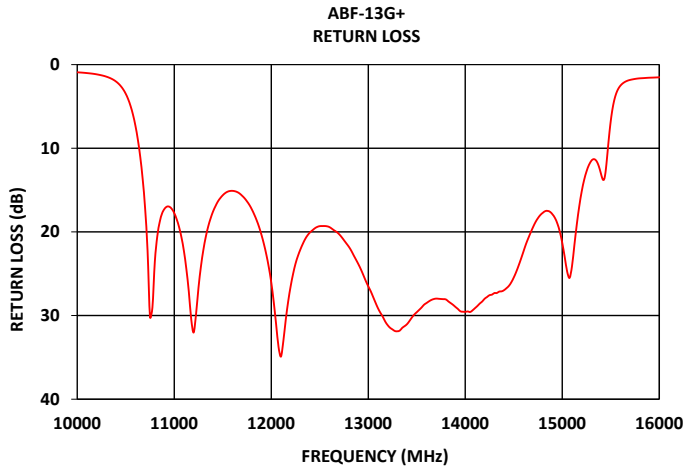
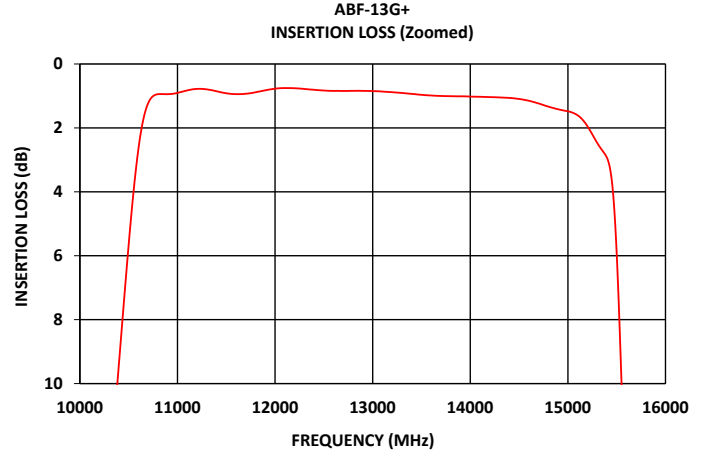
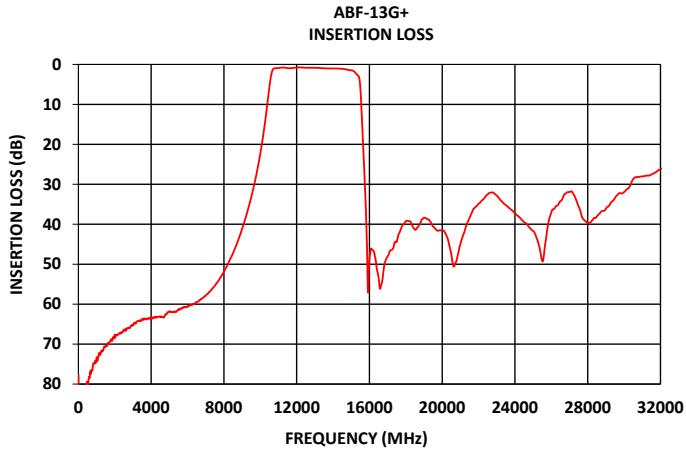
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TYPICAL PERFORMANCE GRAPHS AT +25°C





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THIN FILM SURFACE MOUNT

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FUNCTIONAL DIAGRAM

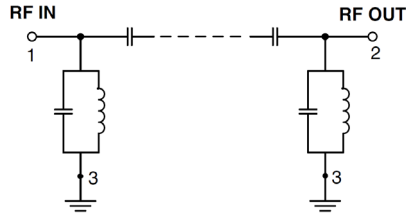
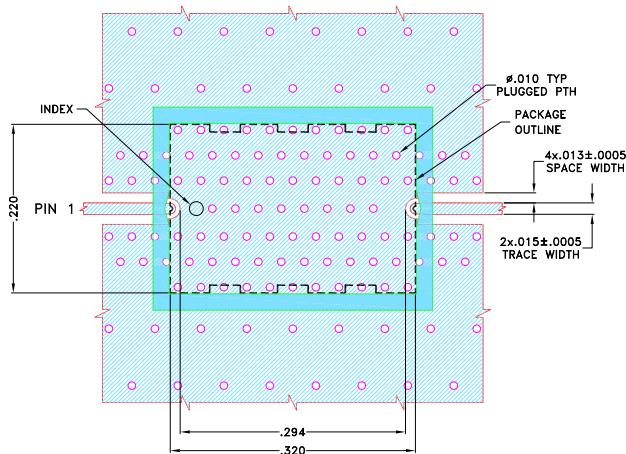


Figure 1. ABF-13G+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1 ²	1	Connects to RF Input Port
RF2 ²	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-764)
NC	—	No connection, not used internally. See drawing PL-764 for connection to PCB

SUGGESTED PCB LAYOUT (PL-764)



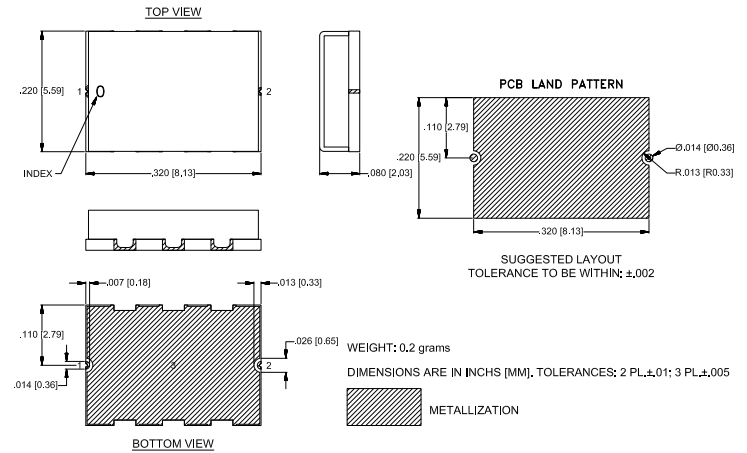
NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B Lo Pro) WITH DIELECTRIC THICKNESS .0073±.0007, COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

■ DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 ■ DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-764

CASE STYLE DRAWING



PRODUCT MARKING*: ABF-13G

*Marking may contain other features or characters for internal lot control.



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THIN FILM SURFACE MOUNT

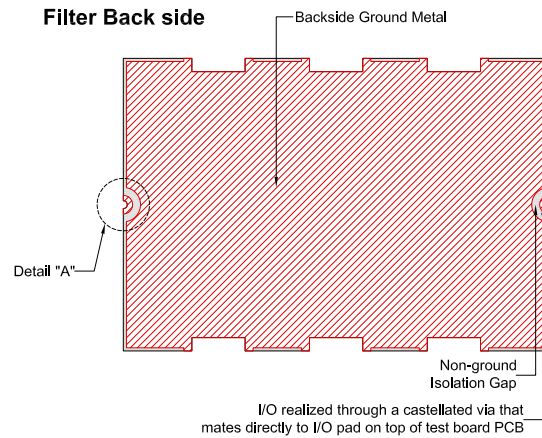
Bandpass Filter

ABF-13G+

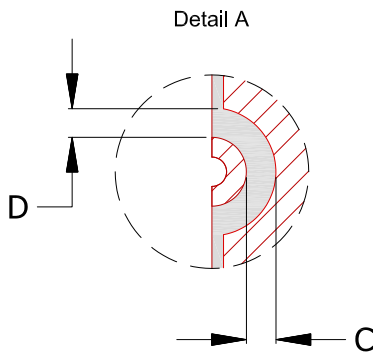
50Ω

11.6 to 14.4 GHz

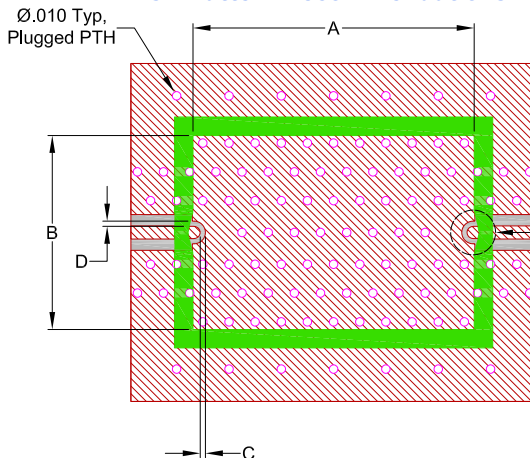
RECOMMENDED PCB LAYOUT PATTERN FOR FILTER



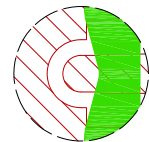
Filter RF I/O Detail
(Filter Back Side)



PCB Pattern Recommendations



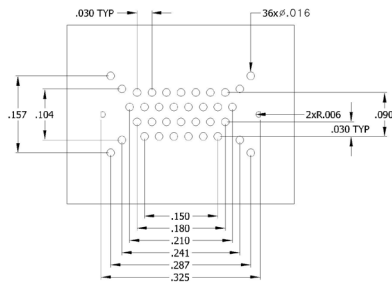
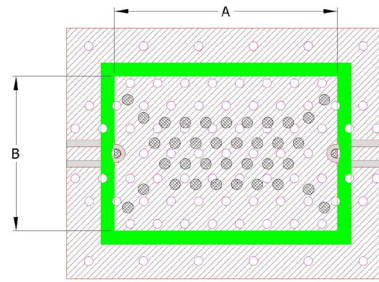
DETAIL "B"

SEE
DETAIL "B"

- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar to filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
- 5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

**COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH**

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing**Solder location after screen print**

- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.



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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD.

[CLICK HERE](#)

Performance Data and Graphs	Data
	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	UC2731 Lead Finish: Gold over Nickel Plate.
RoHS Status	Compliant
Tape and Reel	TR-F003
Suggested Layout for PCB Design	PL-764
Evaluation Board	TB-ABF-13G+
	Gerber File
Environmental Rating	ENV120

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Thin-Film Bandpass Filter

ABF-13G+

Typical Performance Data

FREQ.	Insertion Loss	Input Return Loss	Output Return Loss	FREQ.	Group Delay
(MHz)	(dB)	(dB)	(dB)	(MHz)	(ns)
10	77.71	0.02	0.04	11600	0.74
20	95.51	0.03	0.05	11625	0.73
25	101.01	0.04	0.05	11650	0.73
100	92.69	0.08	0.09	11675	0.73
200	86.33	0.12	0.14	11700	0.73
400	83.89	0.18	0.20	11725	0.73
800	75.22	0.23	0.25	11750	0.73
900	74.86	0.23	0.25	11775	0.73
1000	73.32	0.23	0.25	11800	0.73
2000	67.61	0.21	0.22	11825	0.73
5000	61.79	0.41	0.44	11850	0.73
7500	55.42	0.67	0.69	11875	0.73
9000	41.14	0.71	0.74	12000	0.73
9650	30.40	0.76	0.78	12025	0.73
10075	20.27	0.98	1.00	12050	0.72
10575	3.28	6.00	6.03	12100	0.72
11600	0.94	15.09	15.36	12150	0.72
11800	0.88	17.31	17.66	12200	0.72
12000	0.77	26.03	26.35	12250	0.72
12400	0.81	20.05	20.49	12300	0.72
12600	0.84	19.42	19.78	12350	0.71
13000	0.85	26.50	24.23	12400	0.71
13500	0.96	29.60	28.40	12450	0.71
13600	0.99	28.51	28.12	12500	0.71
13800	1.01	28.07	27.70	12550	0.71
14000	1.02	29.56	28.76	12600	0.71
14200	1.04	27.98	29.92	12650	0.71
14400	1.06	26.96	31.87	12700	0.71
15000	1.48	21.33	23.37	12750	0.71
15410	3.01	13.51	17.17	12800	0.72
15550	10.03	3.65	4.03	12900	0.72
15670	21.94	1.93	2.08	13000	0.72
15800	35.96	1.64	1.74	13050	0.72
16000	48.99	1.52	1.57	13100	0.73
17000	48.06	1.40	1.32	13150	0.73
17500	44.37	1.38	1.26	13200	0.73
18000	39.23	1.40	1.29	13250	0.73
19500	40.58	1.38	1.46	13300	0.73
20000	41.58	1.41	1.52	13350	0.73
20500	47.55	1.41	1.53	13400	0.73
21000	44.91	1.43	1.52	13450	0.74
21500	38.43	1.48	1.50	13500	0.74
22000	34.86	1.55	1.49	13550	0.74
22500	32.51	1.59	1.50	13600	0.74
23000	32.84	1.55	1.45	13650	0.75
23500	35.20	1.52	1.48	13700	0.75
24000	37.24	1.53	1.57	13750	0.75
24500	39.46	1.60	1.70	13800	0.76
25000	41.64	1.70	1.80	13850	0.76
25500	49.22	1.86	1.88	13900	0.76
26000	37.08	2.06	1.96	13950	0.77
26500	34.24	2.16	2.07	14000	0.77
27000	31.92	2.14	2.17	14050	0.78
27500	35.56	2.11	2.28	14100	0.78
28000	39.68	2.20	2.47	14150	0.79
28500	38.01	2.46	2.70	14200	0.79
29000	36.13	2.67	2.93	14250	0.80
30000	31.96	3.04	3.92	14300	0.81
31000	28.04	2.53	2.28	14350	0.82
32000	26.23	2.46	2.60	14400	0.82

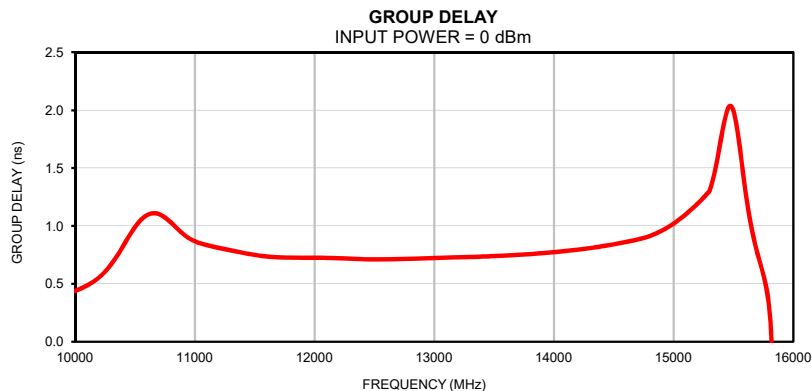
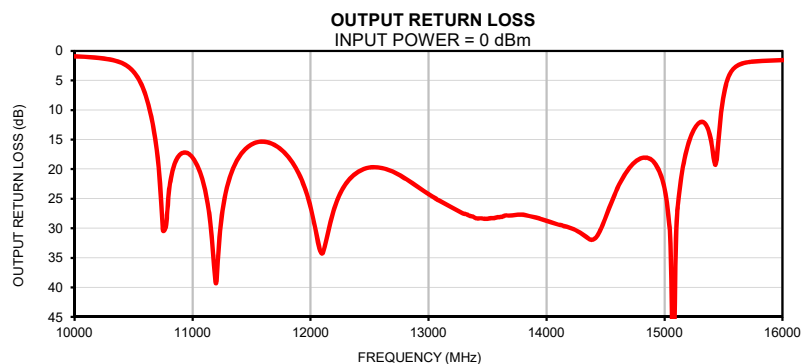
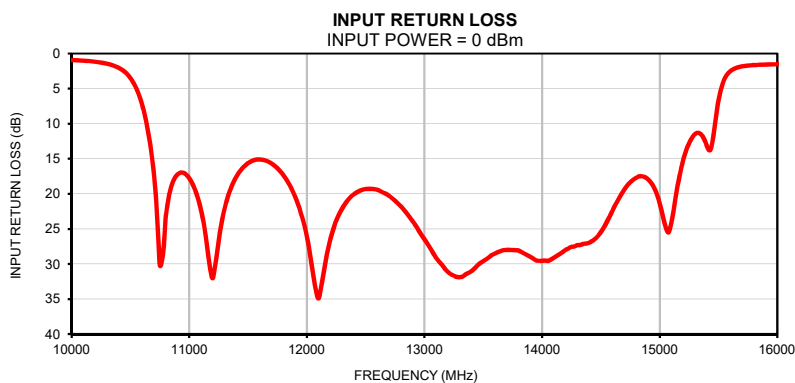
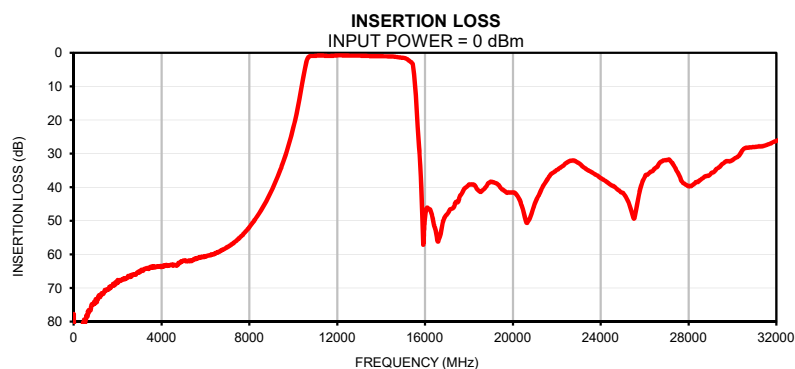


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The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

IF/RF MICROWAVE COMPONENTS

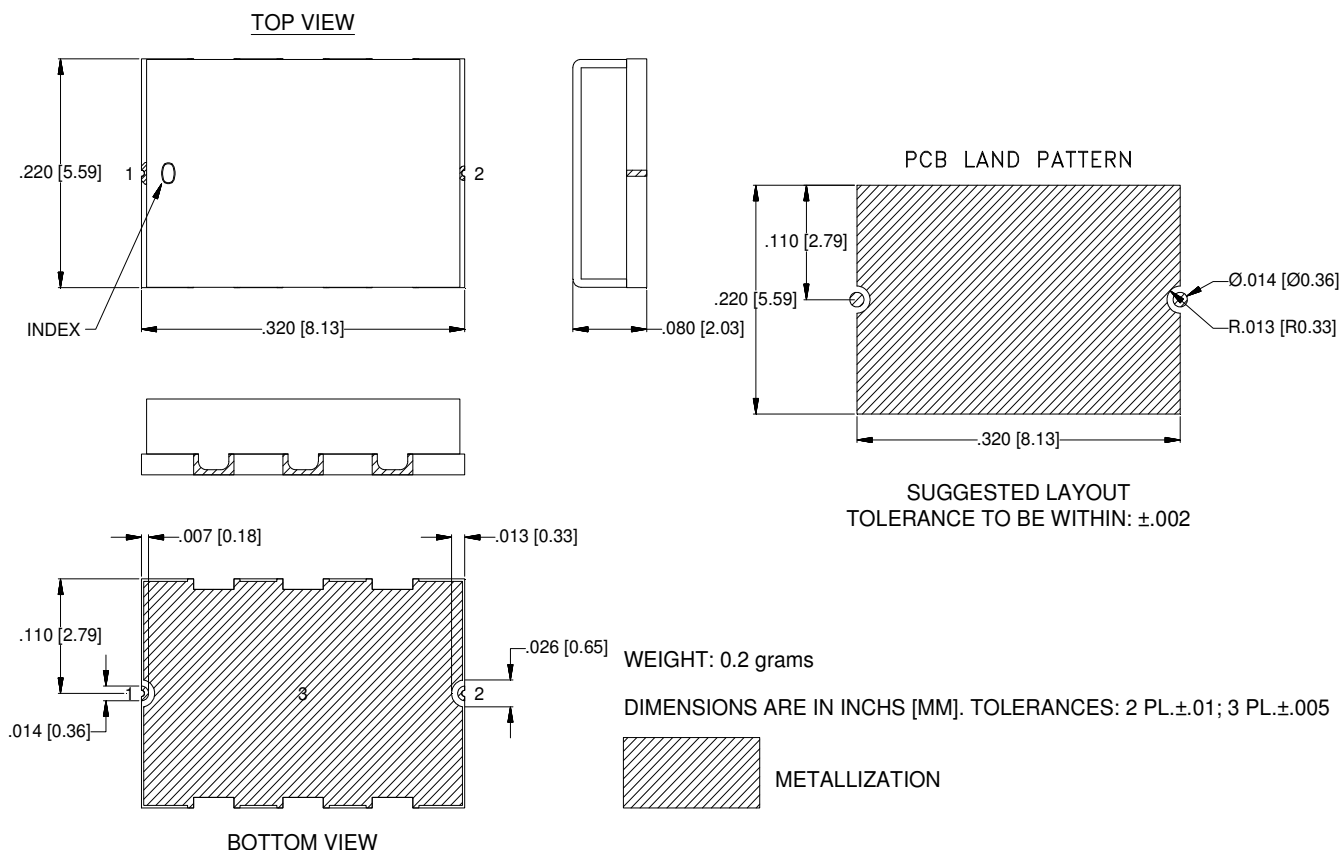
REV.OR
ABF-13G+
250120
Page 1 of 1

Typical Performance Curves



Outline Dimensions

UC2731



Notes:

1. Case material: Gold over Nickel over Annealed Stainless Steel.
2. Base: Ceramic
3. Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.



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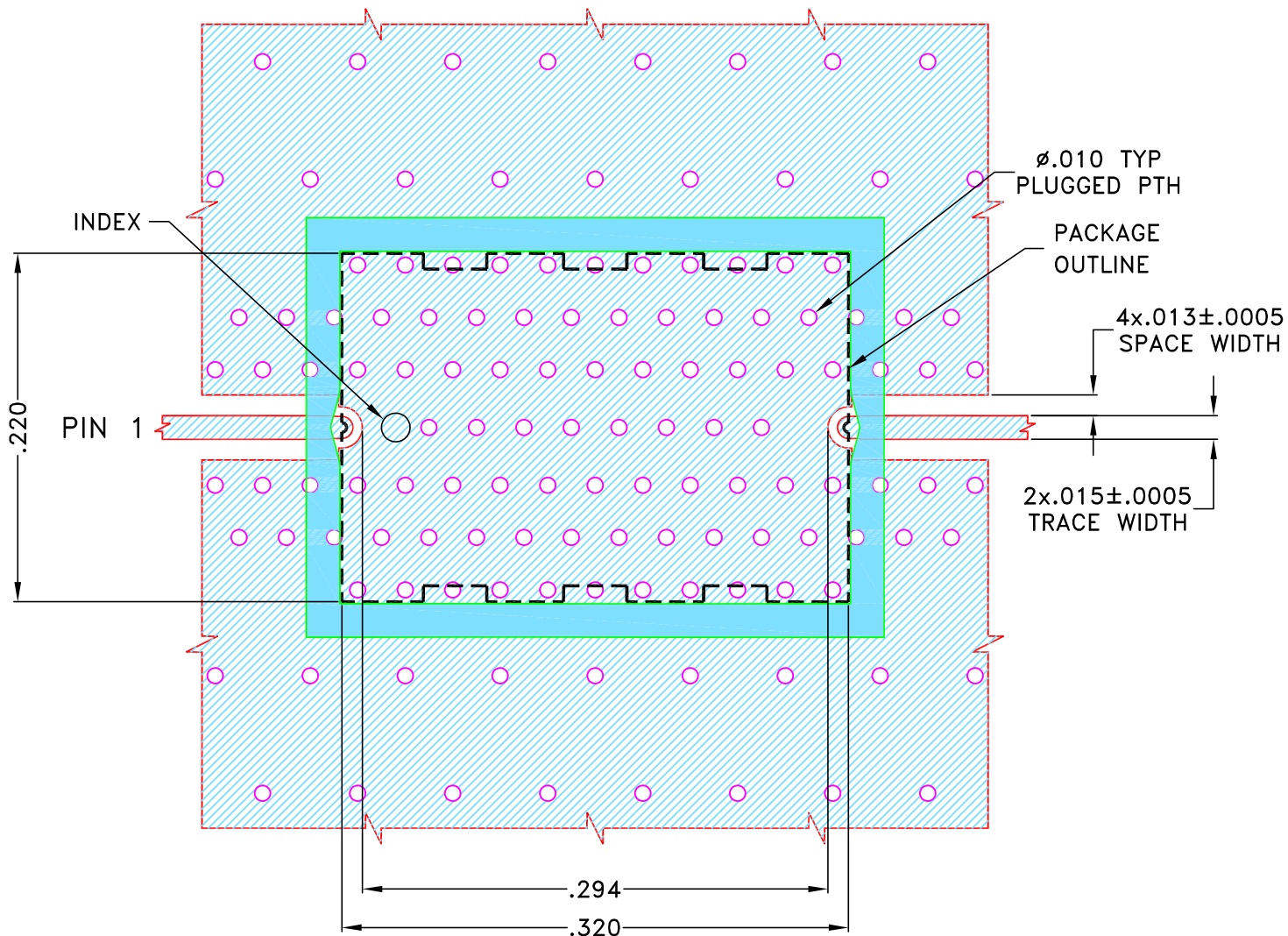
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS



THIRD ANGLE PROJECTION		REVISIONS				
	REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
	OR	NP0-003903	NEW RELEASE	OCT 23	LK	VC

SUGGESTED MOUNTING CONFIGURATION
FOR UC2731 CASE STYLE



NOTES:

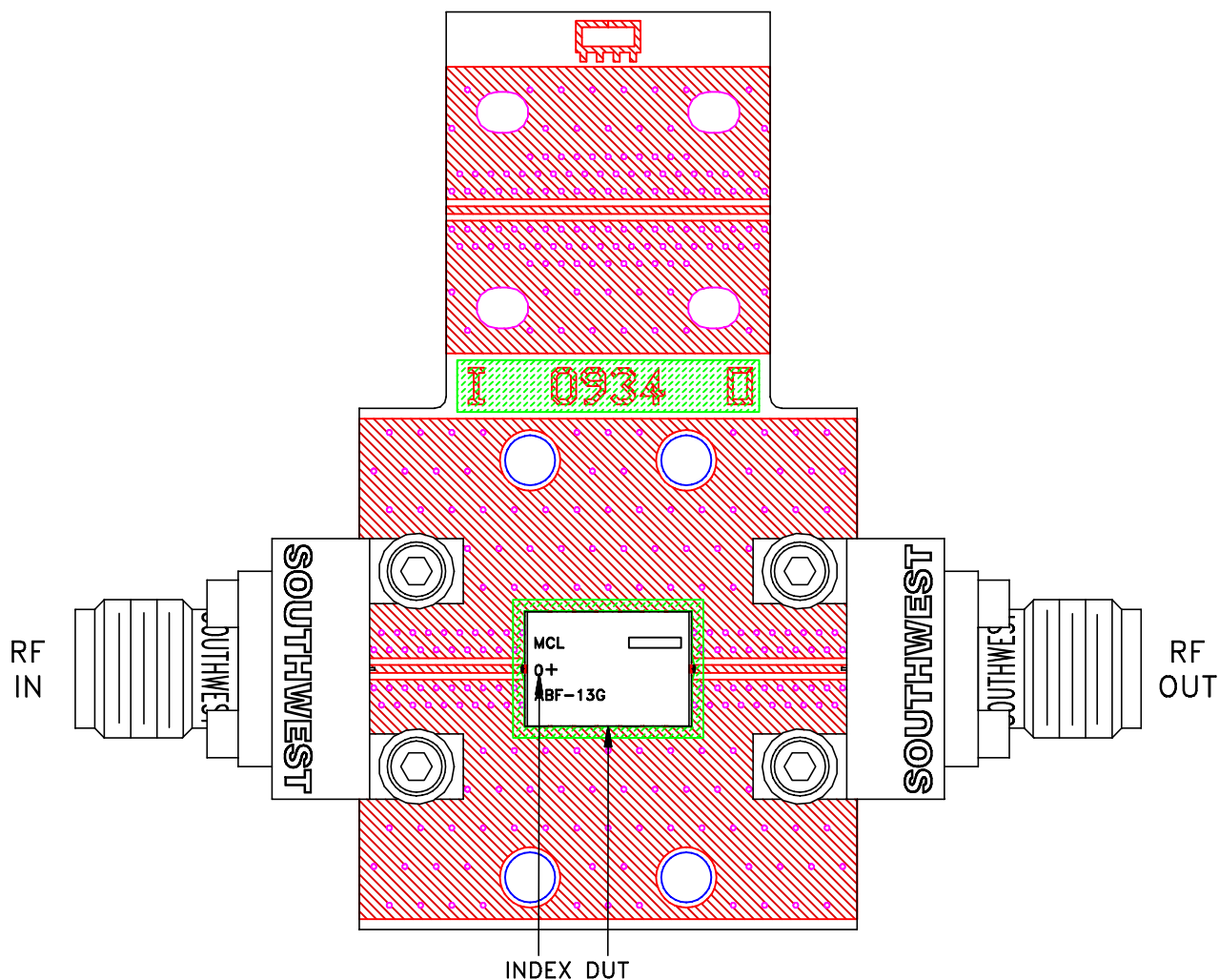
- 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B Lo Pro) WITH DIELECTRIC THICKNESS .0073±.0007. COPPER: 1/2 Oz. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

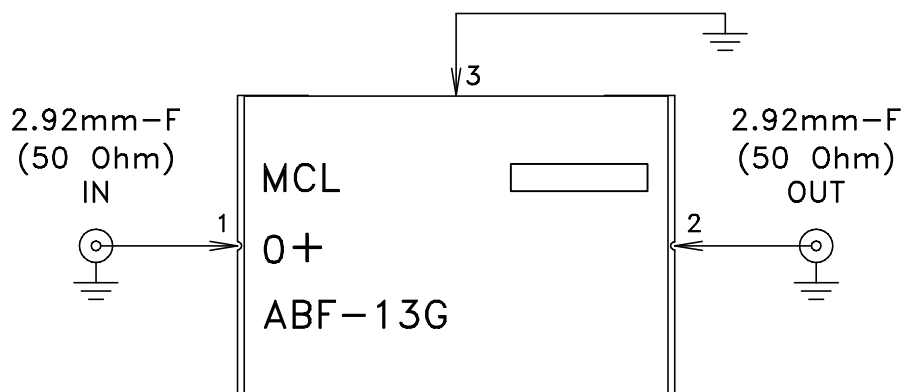
UNLESS OTHERWISE SPECIFIED		INITIALS		DATE		Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235							
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ± 		DRAWN	LK	09 OCT 23									
		CHECKED	MD	09 OCT 23									
		APPROVED	RR	13 OCT 23									
						PL DWG, UC2731 C.S, 50 OHM, ALF							
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ASHEETA1.DWG REV:A DATE:01/12/95						FILE: 98-PL-764		SCALE: 9.1:1		SHEET: 1 OF 1			

Evaluation Board and Circuit

TB-ABF-13G+



Schematic diagram



Notes:

1. PCB Material: ROGERS (R04350B Lo Pro) OR Equivalent, Dielectric Constant= $3.48 \pm .05$
Dielectric Thickness: $.0073 \pm .0007$ inch
2. 50 Ohm 2.92mm Female Connectors.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Thermal Shock	-55° to 125°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, Except +125°C